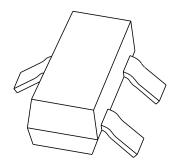
DISCRETE SEMICONDUCTORS

DATA SHEET



BAS19; BAS20; BAS21 General purpose diodes

Product specification Supersedes data of November 1993 File under Discrete Semiconductors, SC01 1996 Apr 16





General purpose diodes

BAS19; BAS20; BAS21

FEATURES

- Small plastic SMD package
- Switching speed: max. 50 ns
- · General application
- Continuous reverse voltage: max. 100; 150; 200 V
- Repetitive peak reverse voltage: max. 120; 200; 250 V
- Repetitive peak forward current: max. 625 mA
- Forward voltage: max. 1 V.

APPLICATIONS

• General purpose switching in e.g. surface mounted circuits.

DESCRIPTION

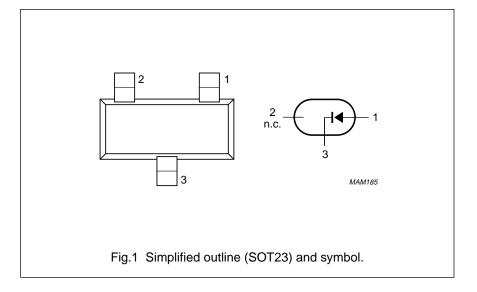
The BAS19, BAS20, BAS21 are general purpose diodes fabricated in planar technology, and encapsulated in small plastic SMD SOT23 packages.

MARKING

TYPE NUMBER	MARKING CODE
BAS19	JPp
BAS20	JRp
BAS21	JSp

PINNING

PIN	DESCRIPTION	
1	anode	
2	not connected	
3	cathode	



General purpose diodes

BAS19; BAS20; BAS21

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{RRM}	repetitive peak reverse voltage				
	BAS19		_	120	V
	BAS20		_	200	V
	BAS21		_	250	V
V _R	continuous reverse voltage				
	BAS19		_	100	V
	BAS20		_	150	V
	BAS21		_	200	V
I _F	continuous forward current	see Fig.2; note 1	_	200	mA
I _{FRM}	repetitive peak forward current		_	625	mA
I _{FSM}	non-repetitive peak forward current	square wave; T _j = 25 °C prior to surge; see Fig.4			
		t = 1 μs	_	9	Α
		t = 100 μs	_	3	Α
		t = 10 ms	_	1.7	Α
P _{tot}	total power dissipation	T _{amb} = 25 °C; note 1	_	250	mW
T _{stg}	storage temperature		-65	+150	°C
T _j	junction temperature			150	°C

Note

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^{1.} Device mounted on an FR4 printed-circuit board.

General purpose diodes

BAS19; BAS20; BAS21

ELECTRICAL CHARACTERISTICS

 $T_i = 25$ °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _F	forward voltage	see Fig.3			
		I _F = 100 mA	_	1.0	V
		I _F = 200 mA	_	1.25	V
I _R	reverse current	see Fig.5			
	BAS19	V _R = 100 V	_	100	nA
		V _R = 100 V; T _j = 150 °C	_	100	μΑ
	BAS20	V _R = 150 V	_	100	nA
		V _R = 150 V; T _j = 150 °C	_	100	μΑ
	BAS21	V _R = 200 V	_	100	nA
		V _R = 200 V; T _j = 150 °C	_	100	μΑ
C _d	diode capacitance	f = 1 MHz; V _R = 0; see Fig.6	_	5	pF
t _{rr}	reverse recovery time	when switched from I _F = 30 mA to	_	50	ns
		I_R = 30 mA; R_L = 100 Ω ; measured at I_R = 3 mA; see Fig.8			

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-tp}	thermal resistance from junction to tie-point		330	K/W
R _{th j-a}	thermal resistance from junction to ambient	note 1	500	K/W

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Note

1. Device mounted on an FR4 printed-circuit board.

General purpose diodes

BAS19; BAS20; BAS21

GRAPHICAL DATA

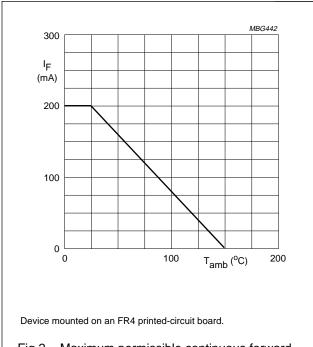
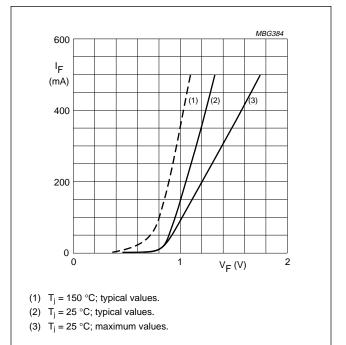
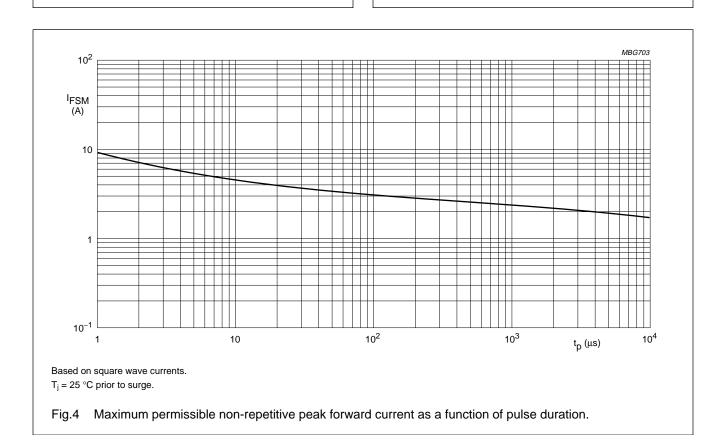


Fig.2 Maximum permissible continuous forward current as a function of ambient temperature.



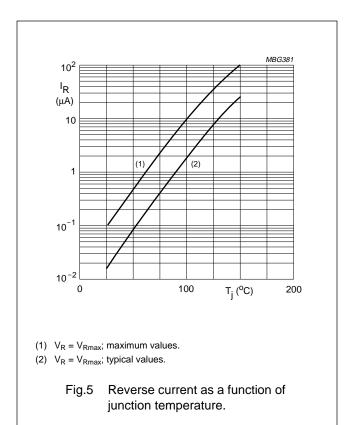
Forward current as a function of

forward voltage.



General purpose diodes

BAS19; BAS20; BAS21



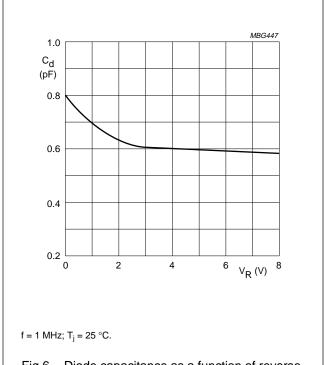
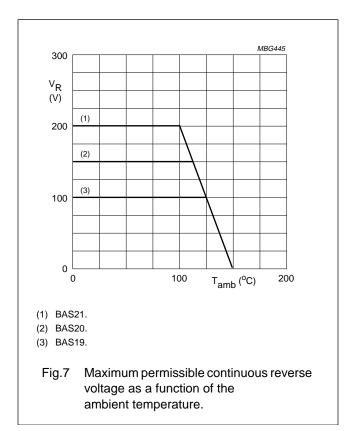
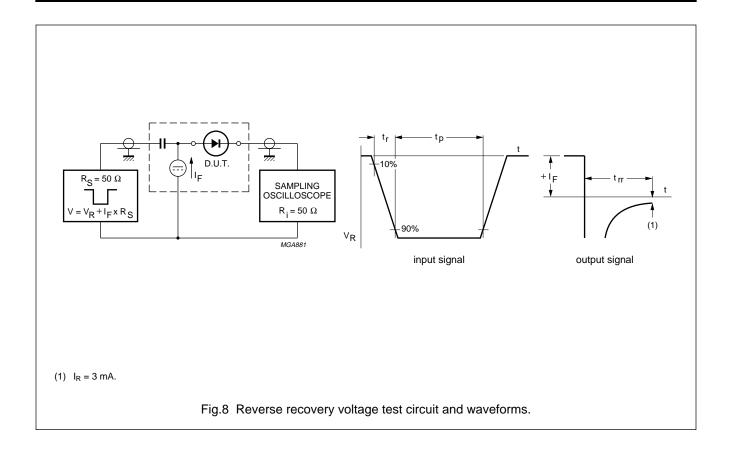


Fig.6 Diode capacitance as a function of reverse voltage; typical values.



General purpose diodes

BAS19; BAS20; BAS21

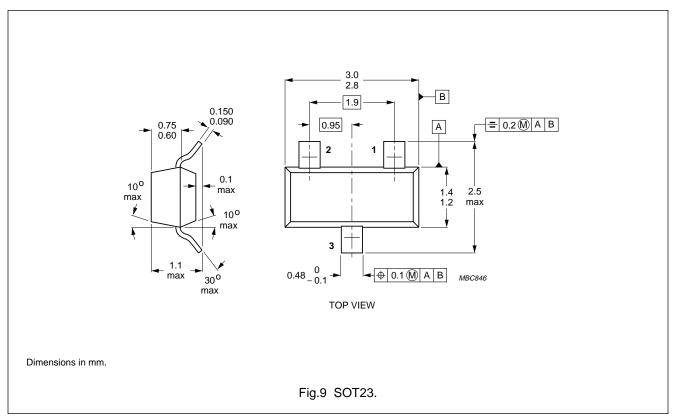


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General purpose diodes

BAS19; BAS20; BAS21

PACKAGE OUTLINE



DEFINITIONS

Data Sheet Status		
Objective specification	This data sheet contains target or goal specifications for product development.	
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.	
Product specification	This data sheet contains final product specifications.	
Limiting values		

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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